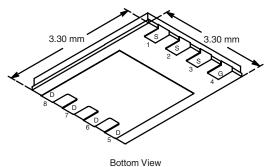


Vishay Siliconix

N-Channel 20-V (D-S) Fast Switching MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A)	Q _g (Typ.)			
20	0.0062 at V_{GS} = 4.5 V	19.5	17.5 nC			
	0.0098 at V_{GS} = 2.5 V	15.5	17.5110			





Ordering Information: Si7106DN-T1-E3 (Lead (Pb)-free)

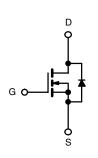
Si7106DN-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

- Halogen-free Option Available
- TrenchFET[®] Power MOSFET
- New Low Thermal Resistance PowerPAK[®] Package with Low 1.07 mm Profile
- PWM Optimized
- 100 % R_q Tested

APPLICATIONS

• Synchronous Rectification



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T_A = 25 °C, unless otherwise noted Parameter Symbol 10 s **Steady State** Unit **Drain-Source Voltage** V_{DS} 20 V ± 12 Gate-Source Voltage V_{GS} $T_A = 25 \degree C$ 19.5 12.5 Continuous Drain Current (T_J = 150 °C)^a I_D $T_A = 70 \degree C$ 15.6 10.0 Pulsed Drain Current 60 I_{DM} А Continuous Source Current (Diode Conduction)^a ls 3.2 1.3 Single Avalanche Current 30 I_{AS} L = 0.1 mHSingle Avalanche Energy E_{AS} 45 mJ $T_A = 25 \ ^{\circ}C$ 3.8 1.5 P_D W Maximum Power Dissipation^a T_A = 70 °C 2.0 0.8 Operating Junction and Storage Temperature Range T_J, T_{stg} - 55 to 150 °C Soldering Recommendations (Peak Temperature)^{b, c} 260

THERMAL RESISTANCE RATINGS								
Parameter		Symbol	Typical	Maximum	Unit			
Manimum lunchian la Anchian I	t ≤ 10 s	R _{thJA}	24	33				
Maximum Junction-to-Ambient ^a	Steady State		65	81	°C/W			
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	1.9	2.4				

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

b. See Solder Profile (http://www.vishay.com/ppg?73257). The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$			1.5	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 12 V$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 20 V, V_{GS} = 0 V$			1	μΑ	
		V_{DS} = 20 V, V_{GS} = 0 V, T_{J} = 55 °C			5		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	40			Α	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 19.5 \text{ A}$		0.0051	0.0062	Ω	
		V _{GS} = 2.5 V, I _D = 15.5 A		0.0081	0.0098		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 19.5 A		105		S	
Diode Forward Voltage ^a	V _{SD}	$I_{\rm S} = 3.2$ A, $V_{\rm GS} = 0$ V		0.8	1.2	V	
Dynamic ^b					1 1		
Total Gate Charge	Qg			17.5	27	nC	
Gate-Source Charge	Q _{gs}	V_{DS} = 10 V, V_{GS} = 4.5 V, I_{D} = 19.5 A		6.6			
Gate-Drain Charge	Q _{gd}			2.8			
Gate Resistance	Rg	f = 1 MHz	0.7	1.4	2.1	Ω	
Turn-On Delay Time	t _{d(on)}			25	40		
Rise Time	t _r	V_{DD} = 10 V, R_L = 10 Ω		15	25	ns	
Turn-Off Delay Time	t _{d(off)}	${\sf I}_{\sf D}\cong$ 1 A, ${\sf V}_{\sf GEN}$ = 10 V, ${\sf R}_{\sf g}$ = 6 Ω		50	75		
Fall Time	t _f			12	20		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 3.2 A, dI/dt = 100 A/μs		30	60		

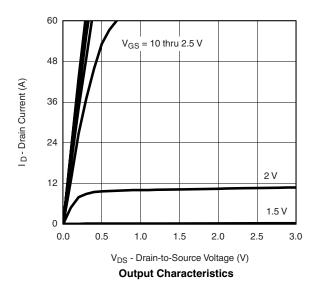
Notes:

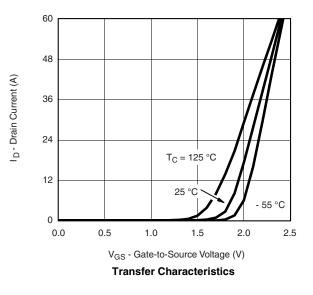
a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

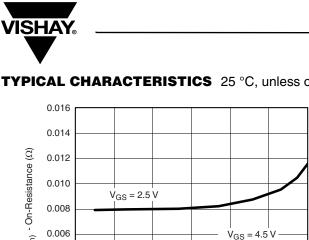
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted







30

I_D - Drain Current (A)

40

50

60

R_{DS(on)} - On-Resistance

0.016 0.014

0.012

0.010

0.008

0.006

0.004

0.002

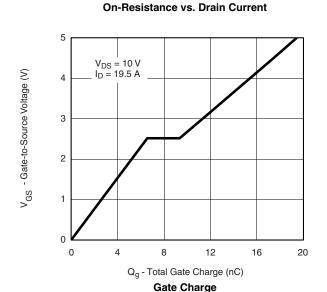
0.000

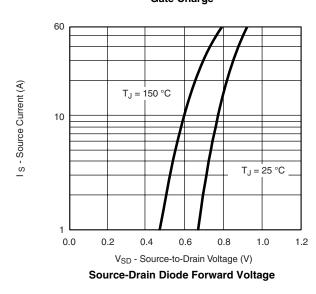
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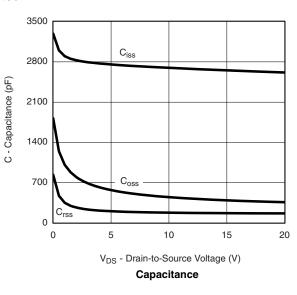
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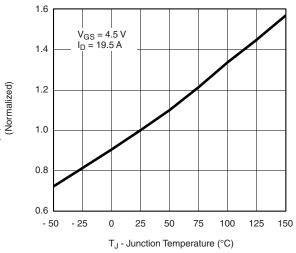
20

R $_{DS(on)}$ - On-Resistance (Ω)

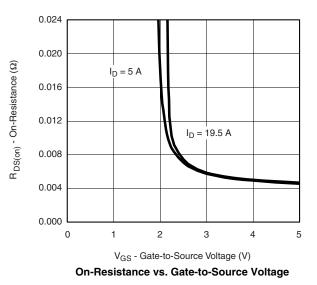








On-Resistance vs. Junction Temperature



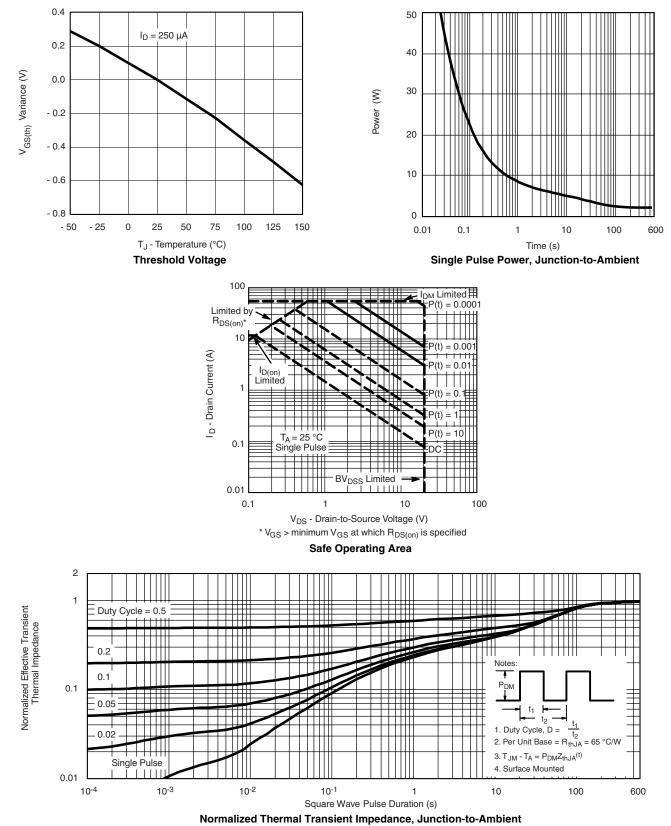
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

Vishay Siliconix

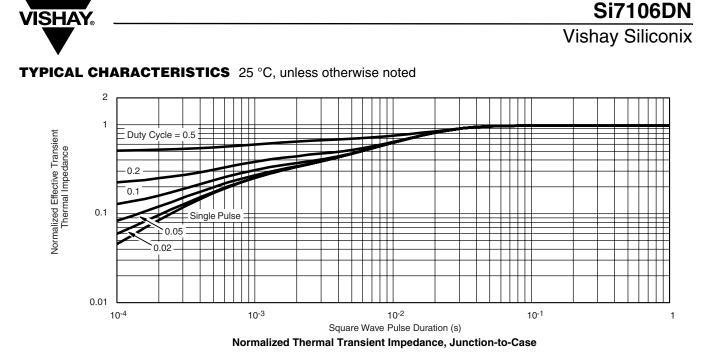
Si7106DN

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted







Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?73142.



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